

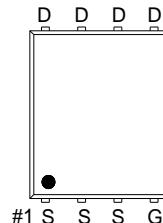
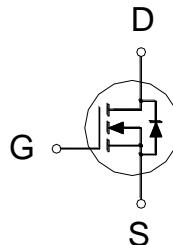
NIKO-SEM**N-Channel Enhancement Mode
Field Effect Transistor****P2610BK**

PDFN 5x6P

Halogen-Free & Lead-Free

PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D
100V	26.8mΩ	25A



G. GATE
D. DRAIN
S. SOURCE

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Drain-Source Voltage		V_{DS}	100	V
Gate-Source Voltage		V_{GS}	± 20	V
Continuous Drain Current ⁴	$T_C = 25^\circ\text{C}$	I_D	25	A
	$T_C = 100^\circ\text{C}$		16	
Pulsed Drain Current ¹		I_{DM}	50	
Continuous Drain Current	$T_A = 25^\circ\text{C}$	I_D	9	
	$T_A = 70^\circ\text{C}$		7	
Avalanche Current		I_{AS}	14	
Avalanche Energy	$L = 1\text{mH}$	E_{AS}	98	mJ
Power Dissipation	$T_C = 25^\circ\text{C}$	P_D	41	W
	$T_C = 100^\circ\text{C}$		17	
Power Dissipation ³	$T_A = 25^\circ\text{C}$	P_D	5	W
	$T_A = 70^\circ\text{C}$		3.2	
Operating Junction & Storage Temperature Range		T_j, T_{stg}	-55 to 150	°C

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE		SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Ambient ²	$t \leq 10\text{s}$	$R_{\theta JA}$	25	50	°C / W
Junction-to-Ambient ²	Steady-State	$R_{\theta JA}$			
Junction-to-Case	Steady-State	$R_{\theta JC}$			

¹Pulse width limited by maximum junction temperature.

²The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^\circ\text{C}$.

³The Power dissipation is based on $R_{\theta JA}$ $t \leq 10\text{s}$ value.

⁴Package limitation current is 29A.

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ELECTRICAL CHARACTERISTICS (T_J = 25 °C, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250μA	100			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	1.3	1.7	2.3	
Gate-Body Leakage	I _{GSS}	V _{DS} = 0V, V _{GS} = ±20V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 100V, V _{GS} = 0V			1	μA
		V _{DS} = 80V, V _{GS} = 0V, T _J = 55 °C			10	
Drain-Source On-State Resistance ¹	R _{DS(ON)}	V _{GS} = 4.5V, I _D = 9A		23	35	mΩ
		V _{GS} = 10V, I _D = 9A		22	26.8	
Forward Transconductance ¹	g _{fs}	V _{DS} = 5V, I _D = 9A		54		S
DYNAMIC						
Input Capacitance	C _{iss}	V _{GS} = 0V, V _{DS} = 25V, f = 1MHz		2013		pF
Output Capacitance	C _{oss}			145		
Reverse Transfer Capacitance	C _{rss}			97		
Gate Resistance	R _g	V _{GS} = 0V, V _{DS} = 0V, f = 1MHz		1		Ω
Total Gate Charge ²	Q _g	V _{GS} = 10V		44		nC
		V _{GS} = 4.5V		24		
Gate-Source Charge ²	Q _{gs}	V _{DS} = 50V , I _D = 9A				
Gate-Drain Charge ²	Q _{gd}			6		
Turn-On Delay Time ²	t _{d(on)}	V _{DS} = 50V , I _D ≈ 9A, V _{GS} = 10V, R _{GEN} = 6Ω		13		nS
Rise Time ²	t _r			16		
Turn-Off Delay Time ²	t _{d(off)}			45		
Fall Time ²	t _f			46		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T_J = 25 °C)						
Continuous Current	I _S				25	A
Forward Voltage ¹	V _{SD}	I _F = 9A, V _{GS} = 0V			1.2	V
Reverse Recovery Time	t _{rr}	I _F = 9A, dI _F /dt = 100A / μS		26		nS
Reverse Recovery Charge	Q _{rr}			19		nC

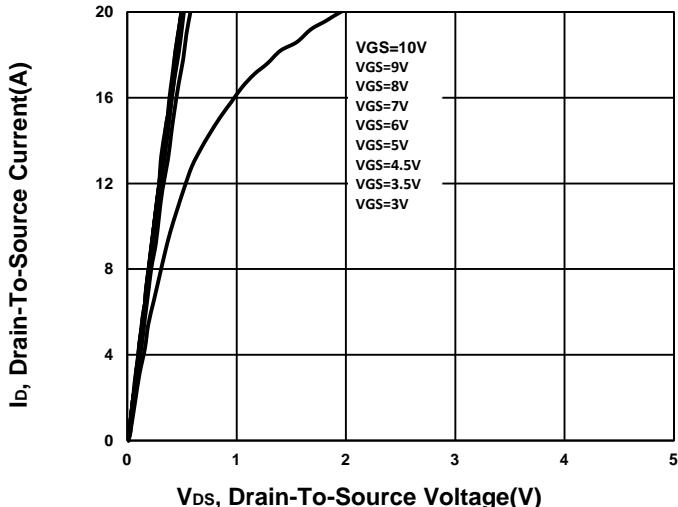
¹Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.²Independent of operating temperature.

NIKO-SEM

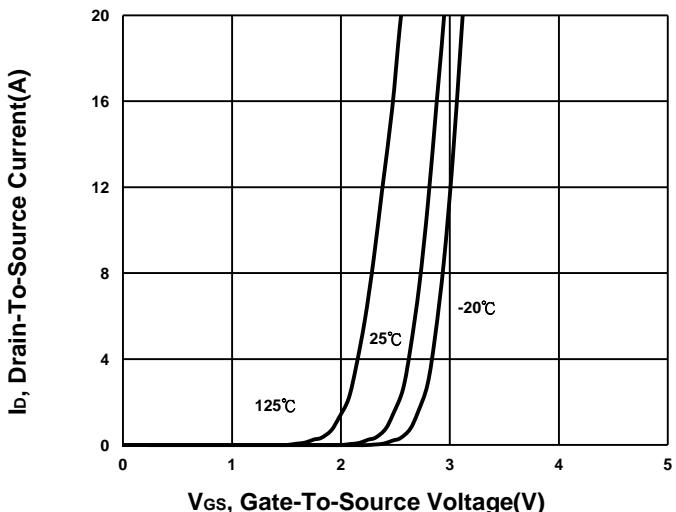
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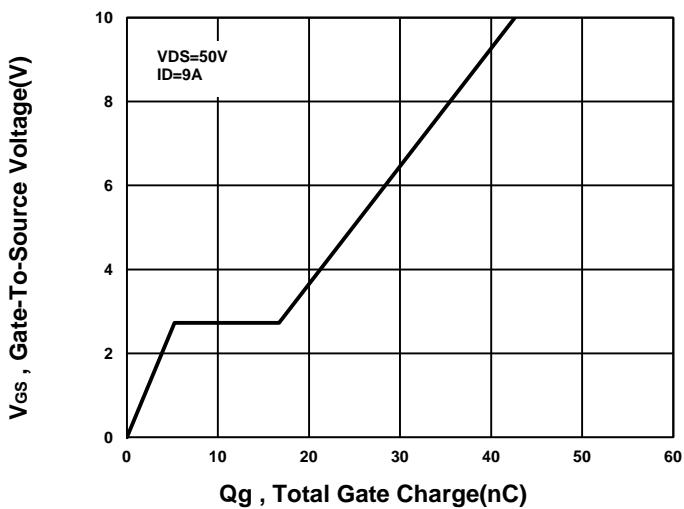
Output Characteristics



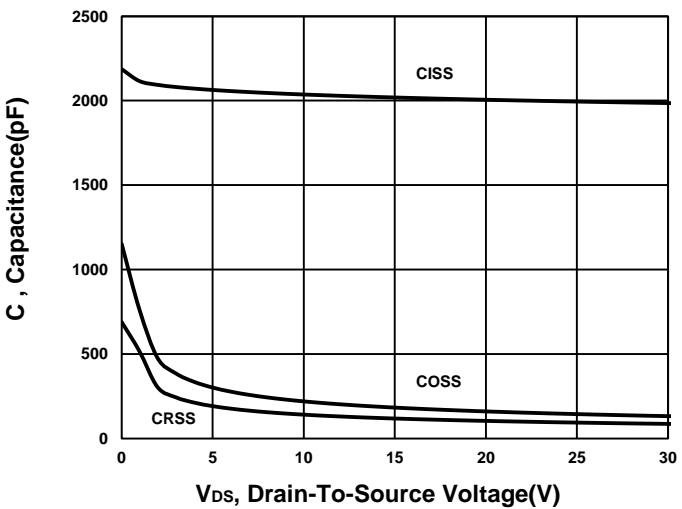
Transfer Characteristics



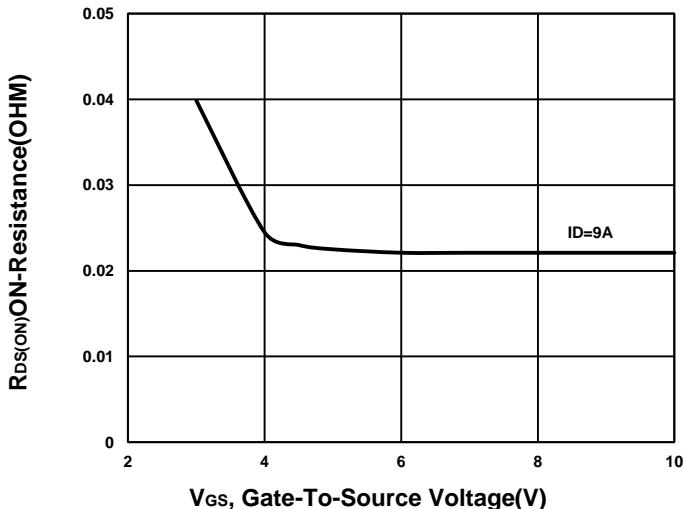
Gate charge Characteristics



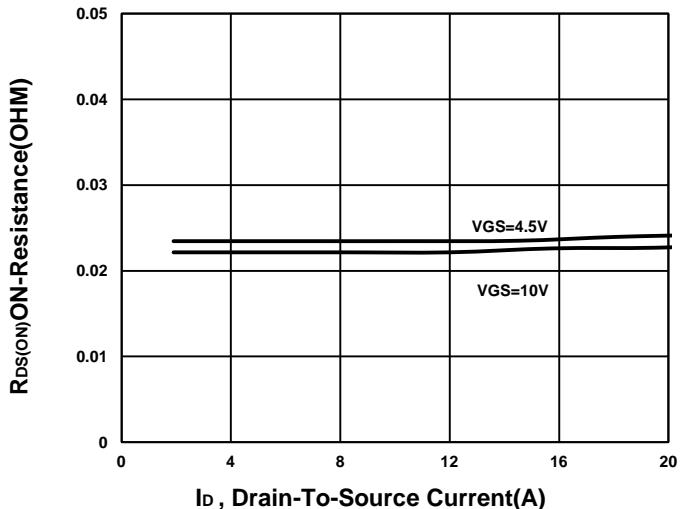
Capacitance Characteristic

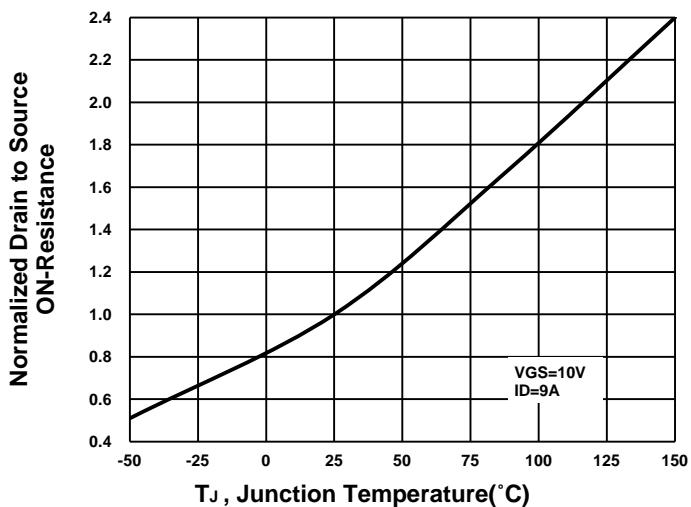
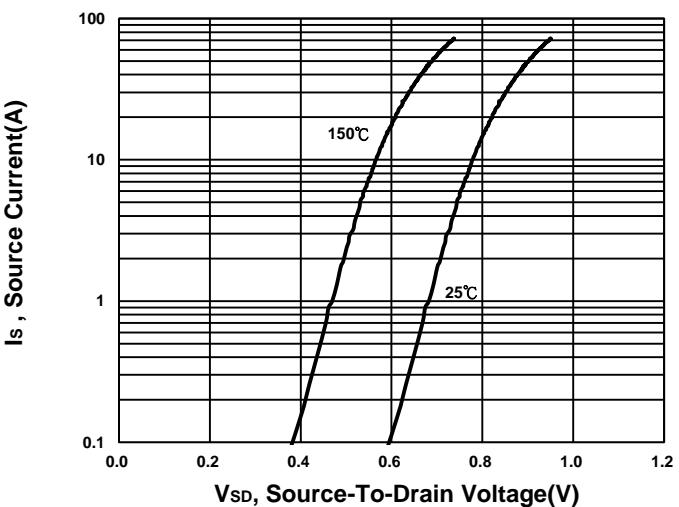
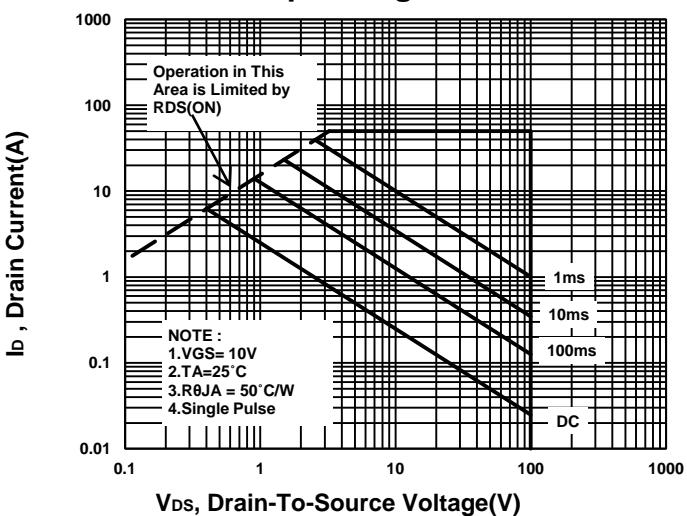
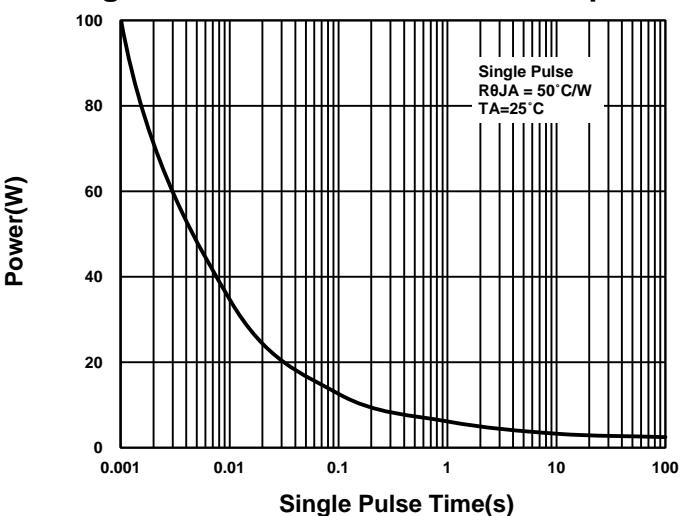


On-Resistance VS Gate-To-Source



On-Resistance VS Drain Current



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Halogen-Free & Lead-Free****On-Resistance VS Temperature****Source-Drain Diode Forward Voltage****Safe Operating Area****Single Pulse Maximum Power Dissipation****Transient Thermal Response Curve**